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Bib Data Sheet

CONFIRMATION NO. 3172

SERIAL NUMBER 09/856,627	FILING DATE 05/24/2001 RULE	CLASS 257	GROUP ART UNIT .2822	ATTORNEY DOCKET NO. 109609	
APPLICANTS Nobuaki Hashimoto, Suwa-shi, JAPAN; ** CONTINUING DATA ***** THIS APPLICATION IS A 371 OF PCT/JP00/06824 09/29/2000 <i>Yes ins</i> ** FOREIGN APPLICATIONS ***** JAPAN 11-281424(P) 10/01/1999 <i>Yes ins</i> IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 12/28/2001					
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged <i>[Signature]</i> Examiner's Signature <i>[Signature]</i> Initials <i>ins</i>		STATE OR COUNTRY JAPAN	SHEETS DRAWING 7	TOTAL CLAIMS 20	INDEPENDENT CLAIMS 2
ADDRESS Oliff & Berridge PO Box 19928 Alexandria, VA 22320					
TITLE Interconnect substrate, semiconductor device, methods of fabricating, inspecting, and mounting the semiconductor device, circuit board, and electronic instrument					
FILING FEE RECEIVED 860	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		